

SanRex®

# TRIAC

## For High Temperature

TMG40CQ60J

 $I_{T(RMS)} = 40A, V_{DRM} = 600V, T_j = 150^\circ C$ 

SanRex Triac **TMG40CQ60J** is specially designed for use in high temperature environment. Thanks to SanRex's new isolated diffusion technology, the **TMG40CQ60J** increases  $T_j(\max)$  from  $125^\circ C$  to  $150^\circ C$ . This advantage reduces the needed heat sink size or eliminate the heat sink. Reducing cooling parts contributes not only to lower cost but also high efficiency and reliability.

## Features

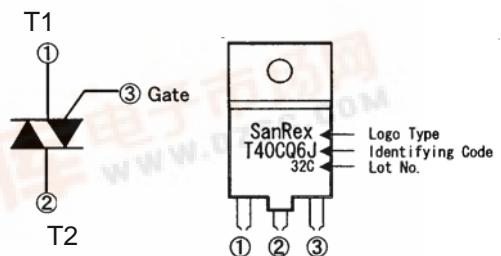
- \* Glass-passivated junctions features
- \* High surge Current
- \* Low voltage drop
- \* Lead-free solder plated terminals
- \* UL registered E76102

## Typical Applications

- \* Home Appliances
- \* Heater Controls
- \* Lighting Controls
- \* Temperature Controls



Isolated TO-3PF Package



Internal schematic diagram

## &lt; Maximum Ratings &gt;

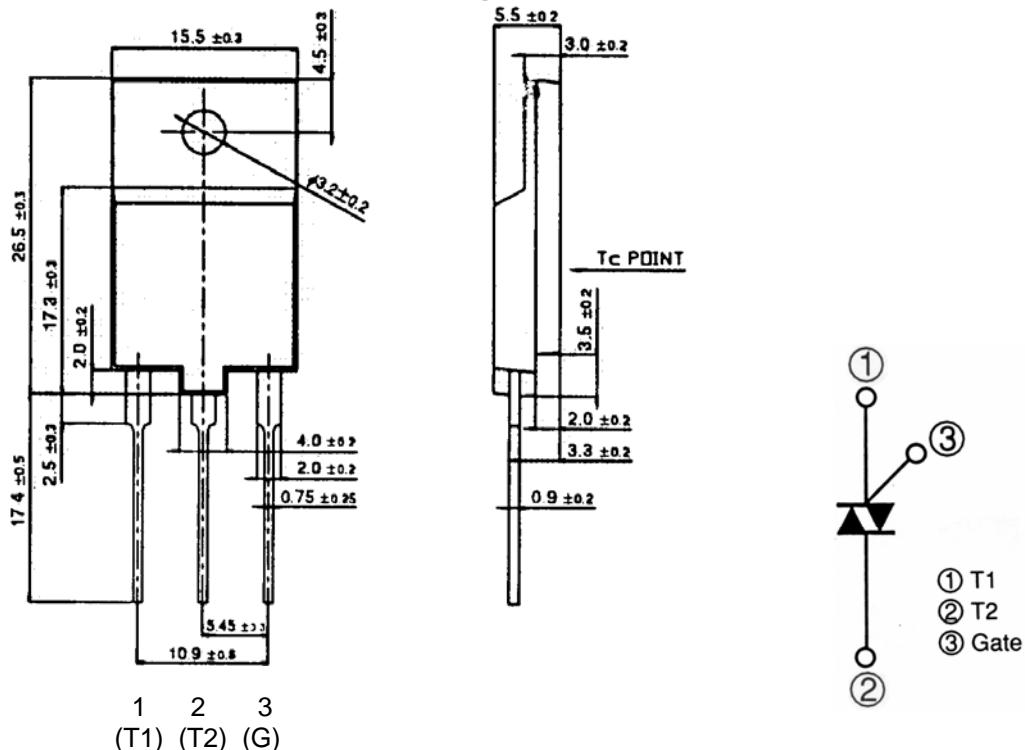
(T<sub>j</sub> = 25°C unless otherwise noted)

Symbol	Item	Conditions	Ratings	Unit
V <sub>DRM</sub>	Repetitive Peak Off-state Voltage		600	V
I <sub>T(RMS)</sub>	R.M.S. On-state Current	T <sub>c</sub> = 98°C	40	A
I <sub>TSM</sub>	Surge On-state Current	One cycle, 60Hz, Peak, non-repetitive	420	A
I <sup>2</sup> t	I <sup>2</sup> t (for fusing)	Value for one cycle surge current	730	A <sup>2</sup> s
P <sub>GM</sub>	Peak Gate Power Dissipation		10	W
P <sub>G(AV)</sub>	Average Gate Power Dissipation		1	W
I <sub>GM</sub>	Peak Gate Current		3	A
V <sub>GM</sub>	Peak Gate Voltage		10	V
V <sub>iso</sub>	Isolation Breakdown Voltage	A.C. 1 minute	1500	V
T <sub>j</sub>	Operation Junction Temperature		-40 to +150	°C
T <sub>stg</sub>	Storage Temperature		-40 to +150	°C
M	Mass	Typical Value	5.6	g

## &lt; Electrical Characteristics &gt;

(T<sub>j</sub>= 25°C unless otherwise noted)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I <sub>DRM</sub>	Repetitive Peak Off-state Current	T <sub>j</sub> = 150°C, V <sub>D</sub> = V <sub>DRM</sub> , Single Phase, Half wave			8	mA
V <sub>TM</sub>	Peak On-State Voltage	I <sub>T</sub> = 60A, Instant measurement			1.4	V
I <sub>GT1+</sub>	QI	V <sub>D</sub> = 6V, I <sub>T</sub> = 1A			50	mA
I <sub>GT1-</sub>	QII				50	mA
I <sub>GT3+</sub>	QIV				-	mA
I <sub>GT3-</sub>	QIII				50	mA
V <sub>GT1+</sub>	QI				1.5	V
V <sub>GT1-</sub>	QII	V <sub>D</sub> = 6V, I <sub>T</sub> = 1A			1.5	V
V <sub>GT3+</sub>	QIV				-	V
V <sub>GT3-</sub>	QIII				1.5	V
V <sub>GD</sub>	Non-Trigger Gate Voltage	T <sub>j</sub> = 150°C, V <sub>D</sub> = 1/2V <sub>DRM</sub>	0.1			V
(dv/dt) <sub>c</sub>	Critical Rate of Rise of Commutation Voltage	T <sub>j</sub> = 150°C, V <sub>D</sub> = 2/3V <sub>DRM</sub> , (di/dt) <sub>c</sub> = -20A/ms	5			V/Fs
I <sub>H</sub>	Holding Current			30		mA
R <sub>th(j-c)</sub>	Thermal Resistance	Junction to case			1.1	°C/W



\* Dimensions in millimeters